

AMENDMENTS TO THE ABSTRACT

Please replace the Abstract of the Disclosure on page 26, beginning at line 3, with the following replacement Abstract of the Disclosure:

~~The invention provides a~~ sound detecting mechanism capable of forming a diaphragm and a back electrode on a substrate by a simple process: includes acoustic

~~Acoustic~~ holes corresponding to perforations ~~Ba~~ are formed on a front surface of a substrate ~~A~~. A second protective film ~~406~~, a sacrificial layer ~~D (407)~~ and a metal film 408 are laminated on the front surface in a portion corresponding to the acoustic holes. The substrate ~~A~~ is etched from the back surface thereof to a depth reaching the acoustic holes to form an acoustic opening ~~E~~. Subsequently, by effecting an etching from the back surface of the substrate ~~A~~ through the acoustic holes, the sacrificial layer 407 is removed and ~~there are formed a void area F~~ a void area is formed between the diaphragm ~~C~~ made of the metal film, 408 and the substrate ~~A~~ and ~~formed the~~ formed perforations ~~Ba~~. The sacrificial layer 407 ~~remaining that remains~~ after the etching is used as a spacer ~~D~~ for maintaining a gap between the back electrode ~~B~~ and the diaphragm ~~C~~.